

# **P25B6EB**

# Power MOSFETs 60V, 25A, N-channel

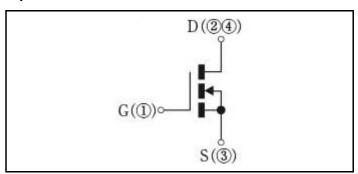
### **Feature**

- N-channel
- SMD
- · Low Ron
- 4.5V Gate Drive
- Low Capacitance
- · Pb free terminal
- RoHS:Yes

## **OUTLINE**



# **Equivalent circuit**



Absolute Maximum Ratings (unless otherwise specified : Tc=25°C)

Item	Symbol	Conditions	Ratings	Unit
Storage temperature	Tstg		-55 to 150	°C
Channel tempertature	Tch		-55 to 150	°C
Drain-source voltage	$V_{DSS}$		60	V
Gate-source voltage	$V_{GSS}$		±20	V
Continuous drain current(DC)	I <sub>D</sub>		25	Α
Continuous drain current(Peak)	I <sub>DP</sub>	Pulse width 10µs, duty=1/100	70	Α
Total power dissipation	P <sub>T</sub>		35	W
Single avalanche current	I <sub>AS</sub>	Starting Tch=25°C Tch≦150°C	16	Α
Single avalanche energy	E <sub>AS</sub>	Starting Tch=25°C Tch≦150°C	29	mJ

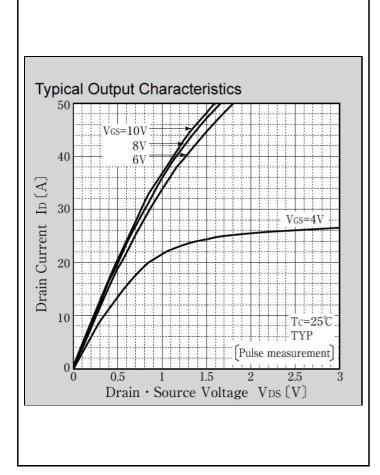
st :See the original Specifications

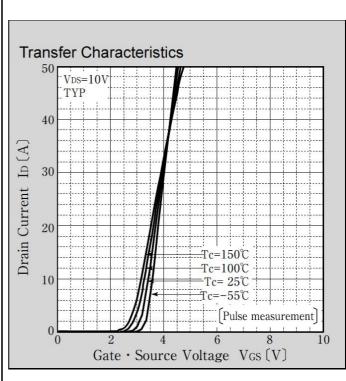
# **Electrical Characteristics** (unless otherwise specified : Tc=25°C)

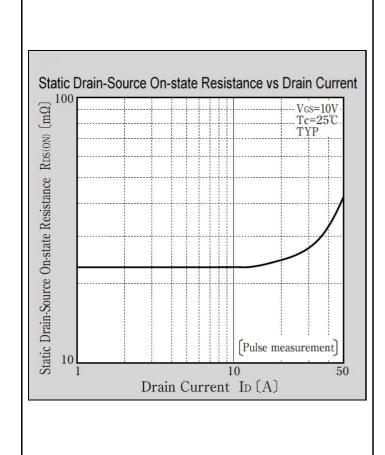
Item	Symbol	Conditions		Ratings		
			MIN	TYP	MAX	Unit
Drain-Source breakdown voltage	$V_{(BR)DSS}$	ID=1mA, VGS=0V	60			V
Zero gate voltage drain current	I <sub>DSS</sub>	VDS=60V, VGS=0V			1	μΑ
Gate-source leakage current	I <sub>GSS</sub>	VGS=±20V, VDS=0V			±10	μA
Forward transconductance	g <sub>fs</sub>	ID=12.5A, VDS=10V	6	12		S
Static drain-source on-state resistance	R <sub>DS(ON)</sub>	ID=12.5A, VGS=10V		0.023	0.029	Ω
Static drain-source on-state resistance	R <sub>DS(ON)</sub>	ID=12.5A, VGS=4.5V		0.0295	0.04	Ω
Gate threshold voltage	Vth	ID=1mA, VDS=10V	1.5	2	2.5	V
Source-drain diode forward voltage	$V_{SD}$	IS=25A, VGS=0V			1.5	V
Thermal resistance	Rth(j-c)	Junction to case, with heatsink *			3.55	°C/W
Total gate charge	Qg	VDD=48V, VGS=10V, ID=25A		14.5		nC
Gate to source charge	Qgs	VDD=48V, VGS=10V, ID=25A		3.3		nC
Gate to drain charge	Qgd	VDD=48V, VGS=10V, ID=25A		4.5		nC
Input capacitance	Ciss	VDS=25V, VGS=0V, f=1MHz		785		pF
Reverce transfer capacitnce	Crss	VDS=25V, VGS=0V, f=1MHz		45		рF
Output capacitance	Coss	VDS=25V, VGS=0V, f=1MHz		115		pF
Turn-on delay time	td(on)	ID=12.5A, RL=2.4Ω, VDD=30V, Rg=0Ω, VGS(+)=10V, VGS(-)=0V		18		ns
Rise time	tr	ID=12.5A, RL=2.4Ω, VDD=30V, Rg=0Ω, VGS(+)=10V, VGS(-)=0V		110		ns
Turn-off delay time	td(off)	ID=12.5A, RL=2.4Ω, VDD=30V, Rg=0Ω, VGS(+)=10V, VGS(-)=0V		55		ns
Fall time	tf	ID=12.5A, RL=2.4Ω, VDD=30V, Rg=0Ω, VGS(+)=10V, VGS(-)=0V		80		ns

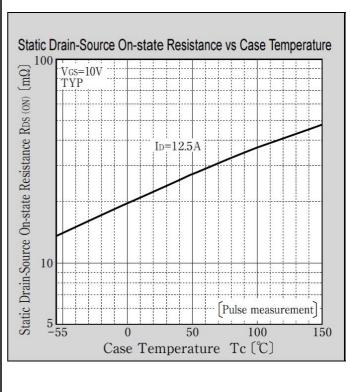
<sup>\*</sup> :See the original Specifications

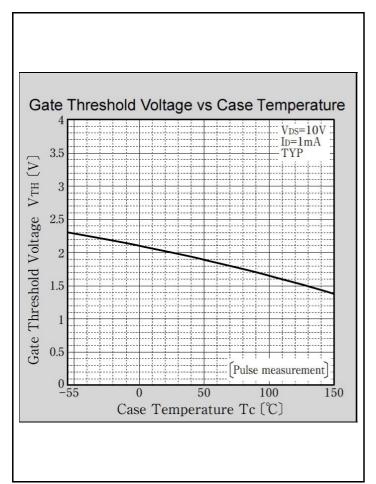
# **CHARACTERISTIC DIAGRAMS**

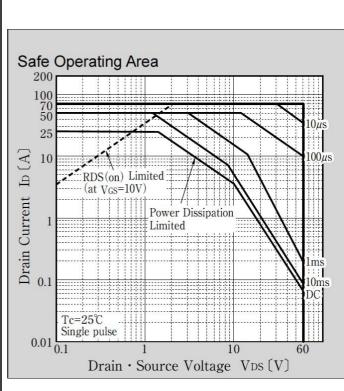


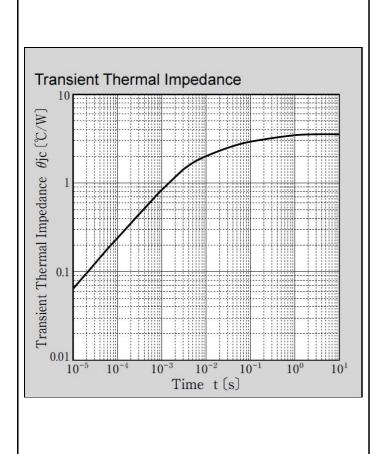


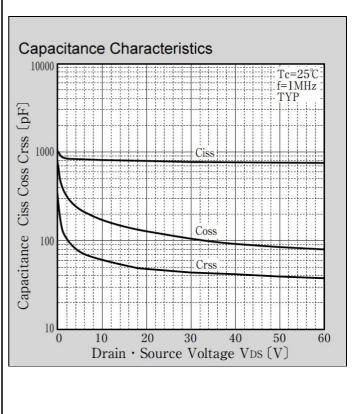


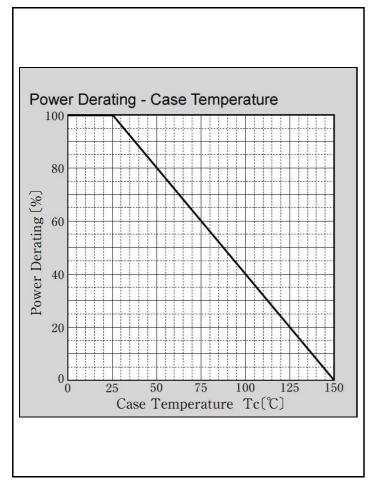


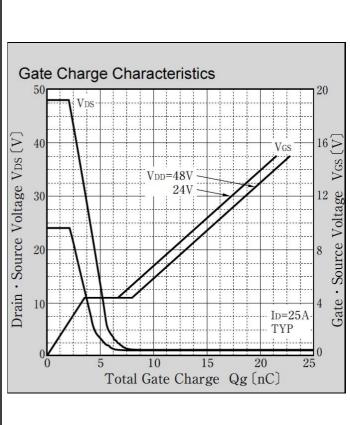


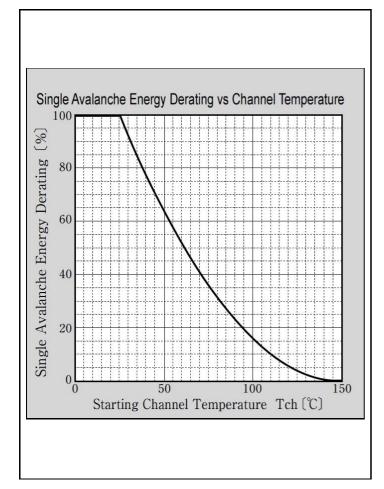






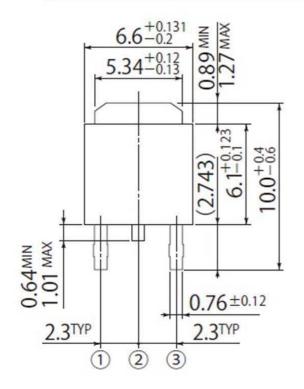


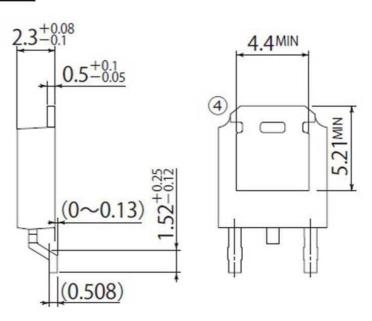


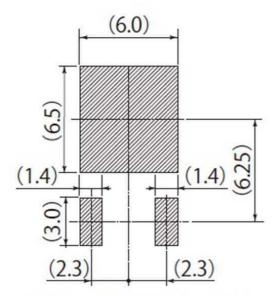


G2

JEDEC Code	TO-252AA	
JEITA Code	_	
House Name	FB	







Referential Soldering Pad

<sup>·</sup> Optimize soldering pad to the board design and soldering condition.

#### **Notes**

- 1. If you wish to use any such product, please be sure to refer to the specifications issued by Shindengen.
- 2. All products described or contained herein are designed with a quality level intended for use in standard applications requiring an ordinary level of reliability. If these products are to be used in equipment or devices for special or specific applications requiring an extremely high grade of quality or reliability in which failures or malfunctions of products may directly affect human life or health, a local Shindengen office must be contacted in advance to confirm that the intended use of the product is appropriate. Shindengen products are grouped into the following three applications according the quality grade.

#### (Standard applications)

Computers, office automation and other office equipment, communication terminals, test and measurement equipment, audio/visual equipment, amusement equipment, consumer electronics, machine tools, personal electronic equipment, industrial equipment, etc.

#### (Special applications)

Transportation equipment (vehicles, ships, etc.), trunk-line communication equipment, traffic signal control systems, antidisaster/crime systems, safety equipment, medical equipment, etc.

#### (Specific applications)

Nuclear reactor control systems, aircraft, aerospace equipment, submarine repeaters, life support equipment and systems, etc.

- 3. Although Shindengen continuously endeavors to enhance the quality and reliability of its products, customers are advised to consider and take safety measures in their design, such as redundancy, fire containment and anti-failure, so that personal injury, fires, or societal damages can be prevented.
- 4. Please note that all information described or contained herein is subject to change without notice due to product upgrades and other reasons. When buying Shindengen products, please contact the Company's offices or distributors to obtain the latest information.
- 5. Shindengen shall not bear any responsibility with regards to damages or infringement of any third-party patent rights and other intellectual property rights incurred due to the use of information on this website.
- 6. The information and materials on this website neither warrant the use of Shindengen's or any third party's patent rights and other intellectual property rights, nor grant license to such rights.
- 7. In the event that any product described or contained herein falls under the category of strategic products controlled under the Foreign Exchange and Foreign Trade Control Law of Japan, exporting of such products shall require an export license from the Japanese government in accordance with the above law.
- 8. No reprinting or reproduction of the materials on this website, either in whole or in part, is permitted without proper authorization from Shindengen.